Hybrids

Module 2 assembled at UniGe

Module completion on April 1st 2010

List of hybrids used:

- H0 and H1 glued on the top side of the module
- H2 and H3 glued on the bottom side of the module

NB: - All hybrids were produced in Japan and are from the latest KEK hybrid design

- All hybrids were set with the on-chip regulator ON (Only Vdd supply of 2.5V needed)

Hybrid ID	Hybrid type	Module Id	Channel defects before assembly	Test before assembly	Test date
HKX2011	H0	#2	-	ok	24.03.2010
HKX2012	H1		-	ok	24.03.2010
HKX2013	H2	#2	-	ok	24.03.2010
HKX2014	H3		-	ok	23.03.2010

- Detectors from Series 2 FZ1 pstop W51(top) and W69(Bottom) glued to baseboard
- **TPG coated with parylene** \rightarrow decided to do parylene coating since module#1
- HV tongue wire bonded (no electrical conductive glue)